



NO. OF POS. RECOMMENDED PCB THICKNESS DIM. A PRODUCT NO. PLATING SPECI PRODUCT NO. | PLATING SPECI PRODUCT NO. | PLATING SPEC 72547-001 72547-001LF 72547-201Lf 1.19 .970 1.32 0.88 4.00 72547-001S 72547-002 NOTE 2 72547-002LF 1.57 1.520 1.83 1.44 4.00 72547-202LF 72547-002S NOTE 16 NOTE 12 72547-003 72547-003S 1.57 1.520 1.83 1.44 5.00 72547-003LF 72547-103S NOTE 10 72547-004 20 1.57 1.520 1.83 4.00 NOTE 72547-204LF 72547-004S

SEE NOTE 16 NOTE 15 SEE NOTE 12 NOTE 15 NOTES:

HOUSING: LCP, UL94V-0 RATED, COLOR: BLACK CONTACTS: PHOSPHOR BRONZE (1) ESD CONTACT: PHOSPHOR BRONZE

- PLATING: CONTACT:  $0.76\mu m$  ( $30\mu$ ") MIN GXT IN CONTACT AREA,  $2.54\mu m$  ( $100\mu$ ") MIN TIN-LEAD ON P.C. BOARD LEG,  $1.27\mu m$  ( $50\mu$ ") MIN. NICKEL UNDERPLATE OVER ENTIRE TERMINAL ESD CONTACT:  $2.54 \mu m$  ( $100\mu$ ") MIN TIN-LEAD PLATING WITH  $1.27\mu m$  ( $50\mu$ ") MIN. NICKEL UNDERPLATE
- 3. MEASURED AT THE FLOOR OF THE CAVITY MEASURED 6mm FROM DATUM -Z- .
- 4.) APPLIES TO ALL SURFACES OF CONTACT TAILS
- (5,) MAXIMUM BOARD THICKNESS THAT CONNECTOR CAN ACCOMODATE IS DEFINED BY "B" DIM.
- (6) THESE DIMENSIONS RESULT IN THE CONTACT RESTING IN CENTER OF PAD WIDTH. THESE DIMENSIONS ARE SUBJECT TO CHANGE DEPENDING ON CUSTOMERS MANUFACTURING PREFERENCES IN PROCESS, SOLDER PLACEMENT AND REFLOW.
- (8.) MEASUREMENT MADE AT THE CENTER OF PART MAY BE AS LOW AS 6.55. DESIGN TO BE MADE TO ACHIEVE THE NOMINAL DIMENSION ACROSS THE ENTIRE PART.
- DISTANCE MEASURED ACROSS CONTACT MATING SURFACES ALONG EFFECTIVE MATING AREA AND CONTACT MUST BE ABOVE PLASTIC ALONG EFFECTIVE MATING AREA.
- PLATING: CONTACT: 0,76μm (30μ") MIN GOLD IN CONTACT AREA, 2.54μm (100μ") MIN TIN-LEAD ON P.C. BOARD LEG, 1.27μm (50μ") MIN. NICKEL UNDERPLATE OVER ENTIRE TERMINAL ESD CONTACT: 2.54 μm (100μ") MIN TIN-LEAD PLATING WITH 1.27μm (50μ") MIN. NICKEL UNDERPLATE

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- PART NUMBERS ENDING IN -0xx or -0xxS or -1xxS ARE MANUFACTURED WITH BRIGHT FINISH TIN-LEAD PLATING IN P.C. BOARD LEG AREA.
- PLATING: CONTACT: 0,76 $\mu$ m (30 $\mu$ ") MIN GOLD IN CONTACT AREA, 2.54 $\mu$ m (100 $\mu$ ") 5.08 $\mu$ m (200 $\mu$ ") TIN ON P.C. BOARD LEG, 1.27 $\mu$ m (50 $\mu$ ") MIN. NICKEL UNDERPLATE OVER ENTIRE TERMINAL ESD CONTACT: 2.54  $\mu$ m (100 $\mu$ ") –5.08 $\mu$ m (200 $\mu$ ") TIN PLATING WITH 1.27 $\mu$ m (50 $\mu$ ") NICKEL UNDERPLATE
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260  $^{\circ}$  C PEAK TEMPERATURE FOR 10 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
- (14) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
- PART NUMBERS ENDING IN "LF" MEANS FOR NOTE 14 LEAD FREE IDENTIFICATION. P/N XXXXX-2XXLF IS EQUIVALENT TO PREVIOUS
- PLATING: CONTACT: 0,76µm (30µ") MIN GXT IN CONTACT AREA, 2.54 $\mu$ m (100 $\mu$ ") – 5.08 $\mu$ m (200 $\mu$ ") TIN ON P.C. BOARD LEG, 1.27 $\mu$ m (50 $\mu$ ") MIN. NICKEL UNDERPLATE OVER ENTIRE TERMINAL ESD CONTACT: 2.54  $\mu$ m (100 $\mu$ ") – 5.08 $\mu$ m (200 $\mu$ ") TIN PLATING WITH 1.27 $\mu$ m (50 $\mu$ ") NICKEL UNDERPLATE

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